Customer No.: 31561 Application No.: 10/604,393 Docket No.: 10026-US-PA

## **AMENDMENTS**

## In The Claims

Claim 1. (currently amended) A multilayer film structure for absorbing electromagnetic wave, comprising:

a plurality of polymer films having a multi-film stacking structure, wherein the polymer films are composed of a carbon group compound structure; and, wherein the carbon group compound structure comprises a carbon containing particle, wherein the carbon containing particle comprises a silicon carbide particle; and

a plurality of permeability films formed on each surface of the polymer films; wherein the carbon containing particle comprises a silicon earbide particle.

Claim 2. (original) The multilayer film structure of claim 1, wherein the permeability films comprise a metal film.

Claim 3. (original) The multilayer film structure of claim 2, wherein a thickness of the metal film is in a range of 10 µm to 100 µm.

Claim 4. (original) The multilayer film structure of claim 2, wherein the metal film comprises an alloy film.

Claim 5. (original) The multilayer film structure of claim 2, wherein the metal film is a stacking layer composed of at least one layer in the group consisted of aluminum layer, nickel layer, iron layer, copper layer and cobalt layer.

Claim 6. (cancelled)

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Claim 7. (currently amended) The multilayer film structure of claim 61, wherein the carbon containing particle comprises a nanoparticle.

Claims 8-9. (cancelled)

Claim 10. (previously presented). The multilayer film structure of claim 1, wherein the polymer films comprise a film having a far-infrared ceramic.

Claims 11-29. (cancelled)